

Final datasheet

High speed and low saturation voltage 650 V TRENCHSTOP™ IGBT7 technology copacked with soft, fast recovery
Emitter Controlled 7 diode

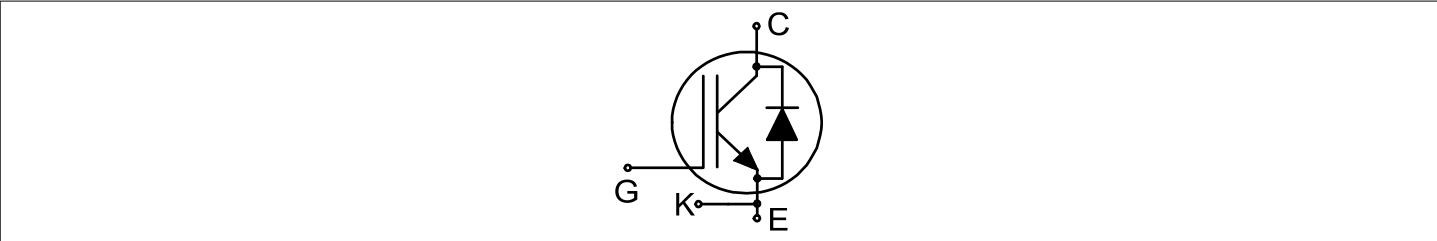
- Features
- $V_{CE} = 650\text{ V}$
 - $I_C = 100\text{ A}$
 - Low switching losses
 - Very low collector-emitter saturation voltage V_{CEsat}
 - Very soft, fast recovery antiparallel diode
 - Smooth switching behavior
 - Humidity robustness
 - Optimized for hard switching, two- and three-level topologies
 - Complete product spectrum and PSpice Models: <http://www.infineon.com/igbt/>

- Potential applications
- Industrial UPS
 - EV-Charging
 - String inverter
 - Welding

- Product validation
- Qualified for industrial applications according to the relevant tests of JEDEC47/20/22



Description



Type	Package	Marking
IKZA100N65EH7	PG-TO247-4-STD-NT3.7	K100EEH7



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1 Package

Table 1 Characteristic values

Parameter	Symbol	Note or test condition	Values			Unit
			Min.	Typ.	Max.	
Internal emitter inductance measured 5 mm (0.197 in.) from case	L_E			13		nH
Storage temperature	T_{stg}		-55		150	°C
Soldering temperature	T_{sold}	wave soldering 1.6 mm (0.063 in.) from case for 10 s			260	°C
Mounting torque	M	M3 screw, Maximum of mounting processes: 3			0.6	Nm
Thermal resistance, junction-ambient	$R_{th(j-a)}$				40	K/W
IGBT thermal resistance, junction-case	$R_{th(j-c)}$			0.27	0.35	K/W
Diode thermal resistance, junction-case	$R_{th(j-c)}$			0.36	0.47	K/W

2 IGBT

Table 2 Maximum rated values

Parameter	Symbol	Note or test condition		Values	Unit
Collector-emitter voltage	V_{CE}	$T_{vj} \geq 25\text{ °C}$		650	V
DC collector current, limited by T_{vjmax}	I_C	limited by bondwire	$T_c = 25\text{ °C}$	140	A
			$T_c = 100\text{ °C}$	136	
Pulsed collector current, t_p limited by T_{vjmax}	I_{Cpulse}			400	A
Turn-off safe operating area		$V_{CE} \leq 650\text{ V}$, $t_p \leq 1\text{ }\mu\text{s}$, $T_{vj} \leq 175\text{ °C}$		400	A
Gate-emitter voltage	V_{GE}			± 20	V
Transient gate-emitter voltage	V_{GE}	$t_p \leq 10\text{ }\mu\text{s}$, $D < 0.01$		± 30	V
Power dissipation	P_{tot}		$T_c = 25\text{ °C}$	429	W
			$T_c = 100\text{ °C}$	214	

Table 3 Characteristic values

Parameter	Symbol	Note or test condition		Values			Unit
				Min.	Typ.	Max.	
Collector-emitter saturation voltage	V_{CEsat}	$I_C = 100\text{ A}$, $V_{GE} = 15\text{ V}$	$T_{vj} = 25\text{ °C}$		1.4	1.65	V
			$T_{vj} = 175\text{ °C}$		1.6		
Gate-emitter threshold voltage	V_{GETh}	$I_C = 0.88\text{ mA}$, $V_{CE} = V_{GE}$		2.9	3.85	4.8	V
Zero gate-voltage collector current	I_{CES}	$V_{CE} = 650\text{ V}$, $V_{GE} = 0\text{ V}$	$T_{vj} = 25\text{ °C}$			30	μA
			$T_{vj} = 175\text{ °C}$		3800		
Gate-emitter leakage current	I_{GES}	$V_{CE} = 0\text{ V}$, $V_{GE} = 20\text{ V}$				100	nA
Transconductance	g_{fs}	$I_C = 100\text{ A}$, $V_{CE} = 20\text{ V}$			145		S
Input capacitance	C_{ies}	$V_{CE} = 25\text{ V}$, $V_{GE} = 0\text{ V}$, $f = 100\text{ kHz}$			5150		pF
Output capacitance	C_{oes}	$V_{CE} = 25\text{ V}$, $V_{GE} = 0\text{ V}$, $f = 100\text{ kHz}$			156.6		pF
Reverse transfer capacitance	C_{res}	$V_{CE} = 25\text{ V}$, $V_{GE} = 0\text{ V}$, $f = 100\text{ kHz}$			21.7		pF
Gate charge	Q_G	$V_{CC} = 520\text{ V}$, $I_C = 100\text{ A}$, $V_{GE} = 15\text{ V}$			207		nC
Turn-on delay time	$t_{d(on)}$	$V_{CC} = 400\text{ V}$, $V_{GE} = 0/15\text{ V}$, $R_{G(on)} = 10\text{ }\Omega$, $R_{G(off)} = 10\text{ }\Omega$	$T_{vj} = 25\text{ °C}$, $I_C = 100\text{ A}$		32		ns
			$T_{vj} = 175\text{ °C}$, $I_C = 100\text{ A}$		30		
Rise time (inductive load)	t_r	$V_{CC} = 400\text{ V}$, $V_{GE} = 0/15\text{ V}$, $R_{G(on)} = 10\text{ }\Omega$, $R_{G(off)} = 10\text{ }\Omega$	$T_{vj} = 25\text{ °C}$, $I_C = 100\text{ A}$		15		ns
			$T_{vj} = 175\text{ °C}$, $I_C = 100\text{ A}$		18		
Turn-off delay time	$t_{d(off)}$	$V_{CC} = 400\text{ V}$, $V_{GE} = 0/15\text{ V}$, $R_{G(on)} = 10\text{ }\Omega$, $R_{G(off)} = 10\text{ }\Omega$	$T_{vj} = 25\text{ °C}$, $I_C = 100\text{ A}$		240		ns
			$T_{vj} = 175\text{ °C}$, $I_C = 100\text{ A}$		277		
Fall time (inductive load)	t_f	$V_{CC} = 400\text{ V}$, $V_{GE} = 0/15\text{ V}$, $R_{G(on)} = 10\text{ }\Omega$, $R_{G(off)} = 10\text{ }\Omega$	$T_{vj} = 25\text{ °C}$, $I_C = 100\text{ A}$		16		ns
			$T_{vj} = 175\text{ °C}$, $I_C = 100\text{ A}$		20		
Turn-on energy	E_{on}	$V_{CC} = 400\text{ V}$, $V_{GE} = 0/15\text{ V}$, $R_{G(on)} = 10\text{ }\Omega$, $R_{G(off)} = 10\text{ }\Omega$	$T_{vj} = 25\text{ °C}$, $I_C = 100\text{ A}$		1.24		mJ
			$T_{vj} = 175\text{ °C}$, $I_C = 100\text{ A}$		1.8		

(table continues...)

Table 3 (continued) Characteristic values

Parameter	Symbol	Note or test condition	Values			Unit
			Min.	Typ.	Max.	
Turn-off energy	E_{off}	$V_{CC} = 400\text{ V}$, $V_{GE} = 0/15\text{ V}$, $R_{G(on)} = 10\ \Omega$, $R_{G(off)} = 10\ \Omega$	$T_{vj} = 25\text{ °C}$, $I_C = 100\text{ A}$	1.22		mJ
			$T_{vj} = 175\text{ °C}$, $I_C = 100\text{ A}$	2.1		
Total switching energy	E_{ts}	$V_{CC} = 400\text{ V}$, $V_{GE} = 0/15\text{ V}$, $R_{G(on)} = 10\ \Omega$, $R_{G(off)} = 10\ \Omega$	$T_{vj} = 25\text{ °C}$, $I_C = 100\text{ A}$	2.46		mJ
			$T_{vj} = 175\text{ °C}$, $I_C = 100\text{ A}$	3.9		
Operating junction temperature	T_{vj}		-40		175	°C

3 Diode

Table 4 Maximum rated values

Parameter	Symbol	Note or test condition	Values	Unit
Diode forward current, limited by T_{vjmax}	I_F	limited by bondwire	$T_c = 25\text{ °C}$	A
			$T_c = 100\text{ °C}$	
Diode pulsed current, t_p limited by T_{vjmax}	I_{Fpulse}		400	A
Power dissipation	P_{tot}	$T_c = 25\text{ °C}$	316	W
		$T_c = 100\text{ °C}$	158	

Table 5 Characteristic values

Parameter	Symbol	Note or test condition	Values			Unit
			Min.	Typ.	Max.	
Diode forward voltage	V_F	$I_F = 100\text{ A}$	$T_{vj} = 25\text{ °C}$	1.65	2	V
			$T_{vj} = 175\text{ °C}$	1.55		
Diode reverse recovery time	t_{rr}	$V_R = 400\text{ V}$, $R_{G(on)} = 10\ \Omega$	$T_{vj} = 25\text{ °C}$, $I_F = 100\text{ A}$	62		ns
			$T_{vj} = 175\text{ °C}$, $I_F = 100\text{ A}$	122		
Diode reverse recovery charge	Q_{rr}	$V_R = 400\text{ V}$, $R_{G(on)} = 10\ \Omega$	$T_{vj} = 25\text{ °C}$, $I_F = 100\text{ A}$	2.5		μC
			$T_{vj} = 175\text{ °C}$, $I_F = 100\text{ A}$	6.3		

(table continues...)

Table 5 (continued) Characteristic values

Parameter	Symbol	Note or test condition	Values			Unit
			Min.	Typ.	Max.	
Diode peak reverse recovery current	I_{rrm}	$V_R = 400 \text{ V}, R_{G(on)} = 10 \text{ } \Omega$		$T_{vj} = 25 \text{ } ^\circ\text{C}, I_F = 100 \text{ A}$	76.4	A
				$T_{vj} = 175 \text{ } ^\circ\text{C}, I_F = 100 \text{ A}$	102	
Diode peak rate of fall of reverse recovery current	di_{rr}/dt	$V_R = 400 \text{ V}, R_{G(on)} = 10 \text{ } \Omega$		$T_{vj} = 25 \text{ } ^\circ\text{C}, I_F = 100 \text{ A}$	-2590	A/ μs
				$T_{vj} = 175 \text{ } ^\circ\text{C}, I_F = 100 \text{ A}$	-1820	
Reverse recovery energy	E_{rec}	$V_R = 400 \text{ V}, R_{G(on)} = 10 \text{ } \Omega$		$T_{vj} = 25 \text{ } ^\circ\text{C}, I_F = 100 \text{ A}$	0.63	mJ
				$T_{vj} = 175 \text{ } ^\circ\text{C}, I_F = 100 \text{ A}$	1.66	
Operating junction temperature	T_{vj}		-40		175	$^\circ\text{C}$

Note: For optimum lifetime and reliability, Infineon recommends operating conditions that do not exceed 80% of the maximum ratings stated in this datasheet.

Electrical Characteristic at $T_{vj} = 25^\circ\text{C}$, unless otherwise specified.

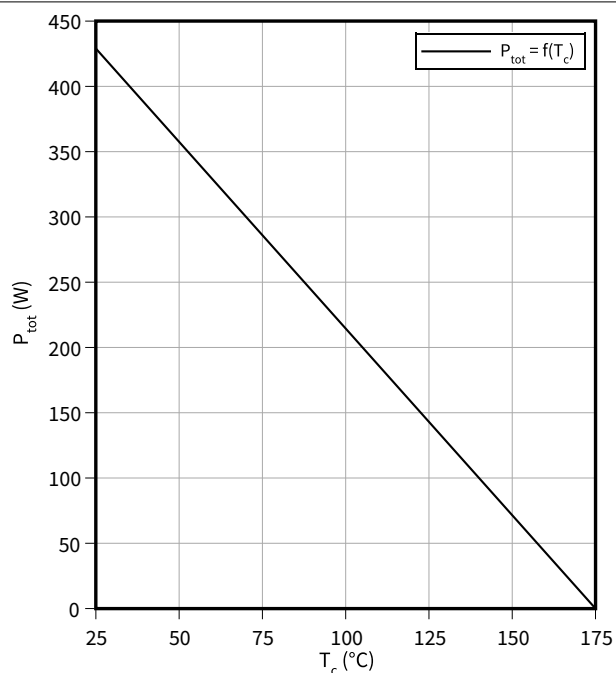
Dynamic test circuit, parasitic inductance $L_\sigma = 8 \text{ nH}$, parasitic capacitor $C_\sigma = 30 \text{ pF}$ from Fig. E. Energy losses include "tail" and diode reverse recovery.

4 Characteristics diagrams

Power dissipation as a function of case temperature

$$P_{\text{tot}} = f(T_c)$$

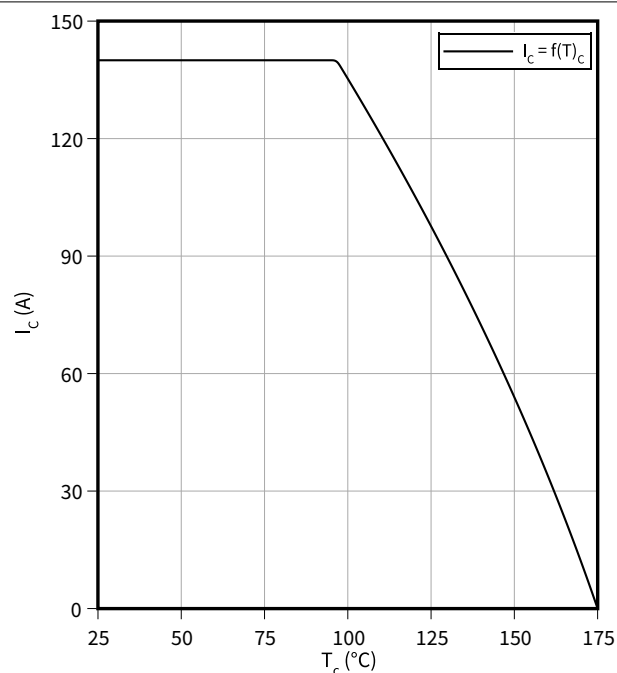
$$T_{vj} \leq 175^\circ\text{C}$$



Collector current as a function of case temperature

$$I_c = f(T_c)$$

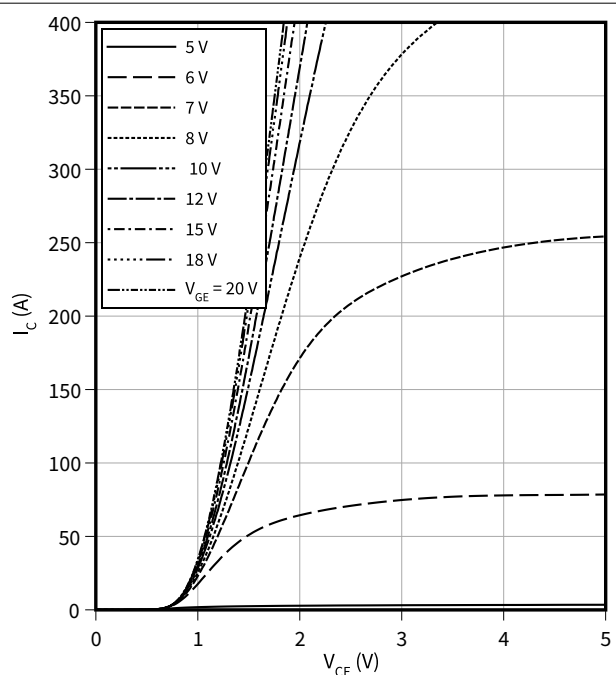
$$T_{vj} \leq 175^\circ\text{C}, V_{GE} \geq 15\text{ V}$$



Typical output characteristic

$$I_c = f(V_{CE})$$

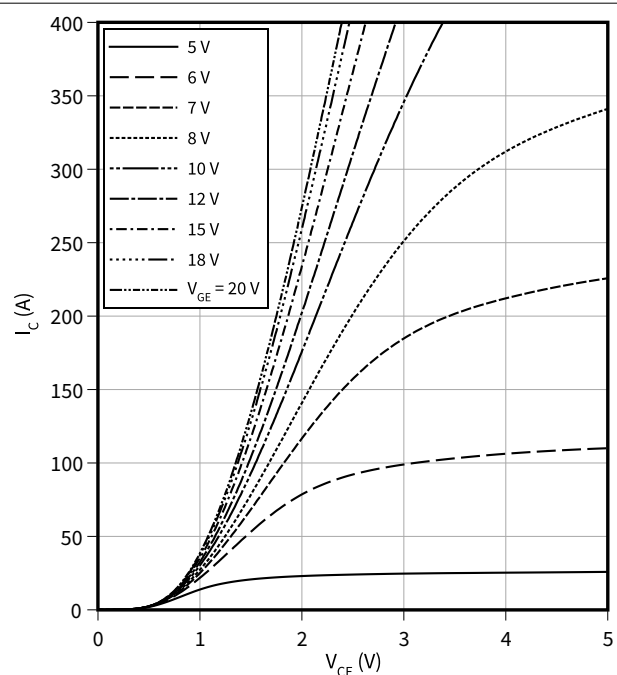
$$T_{vj} = 25^\circ\text{C}$$



Typical output characteristic

$$I_c = f(V_{CE})$$

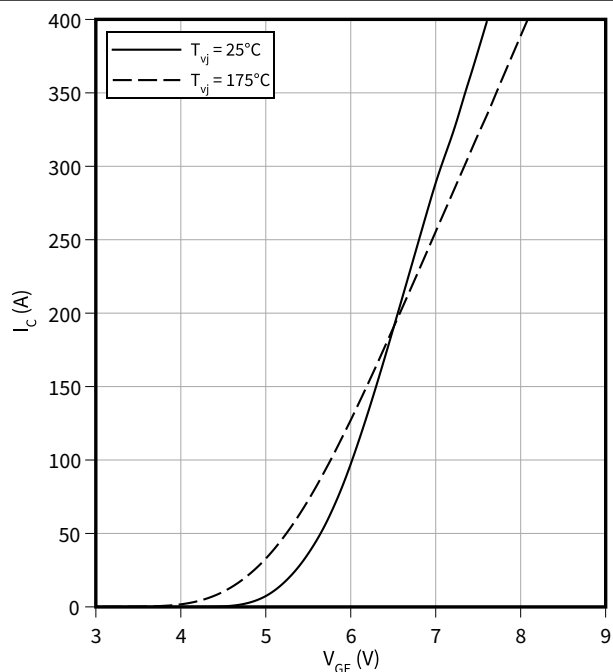
$$T_{vj} = 175^\circ\text{C}$$



4 Characteristics diagrams
Typical transfer characteristic

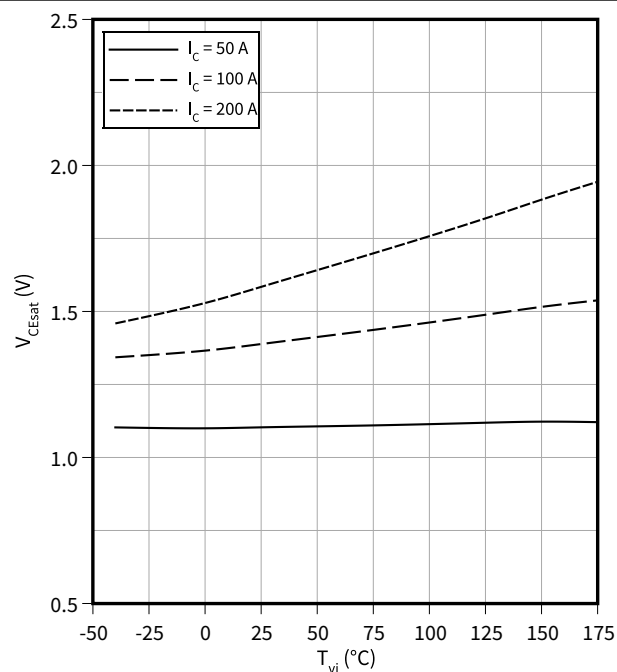
$$I_C = f(V_{GE})$$

$$V_{CE} = 20 \text{ V}$$


Typical collector-emitter saturation voltage as a function of junction temperature

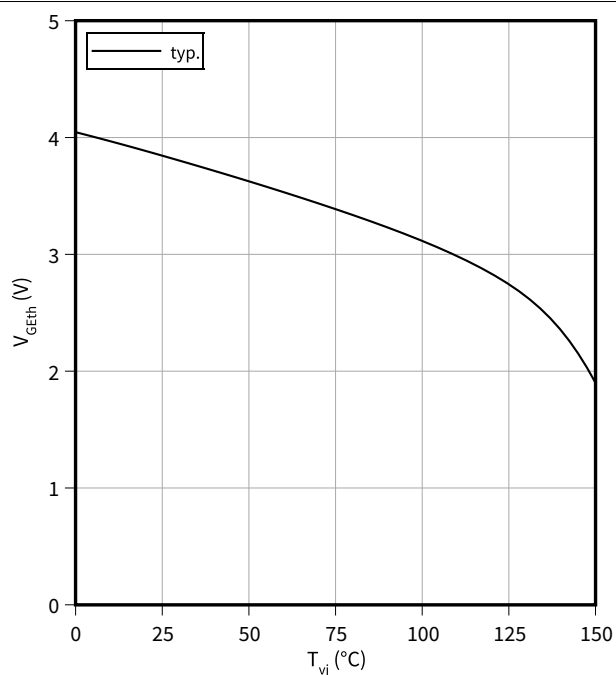
$$V_{CEsat} = f(T_{vj})$$

$$V_{GE} = 15 \text{ V}$$


Gate-emitter threshold voltage as a function of junction temperature

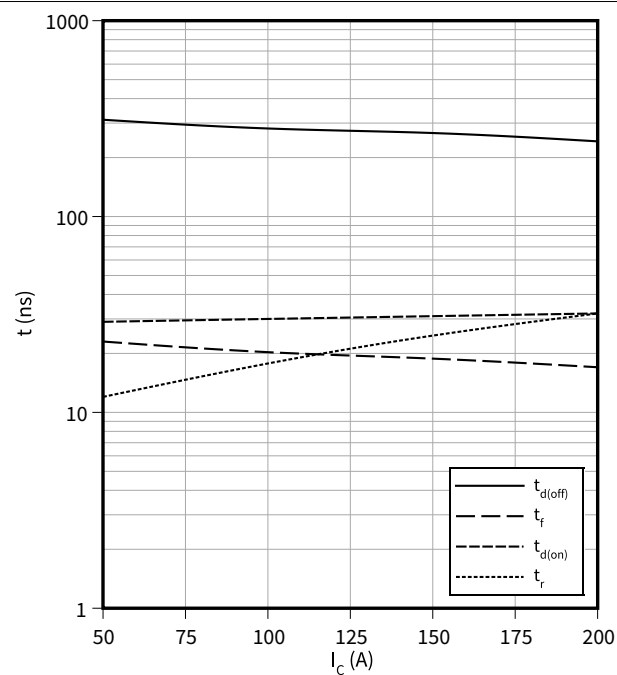
$$V_{GEth} = f(T_{vj})$$

$$I_C = 0.88 \text{ mA}$$


Typical switching times as a function of collector current

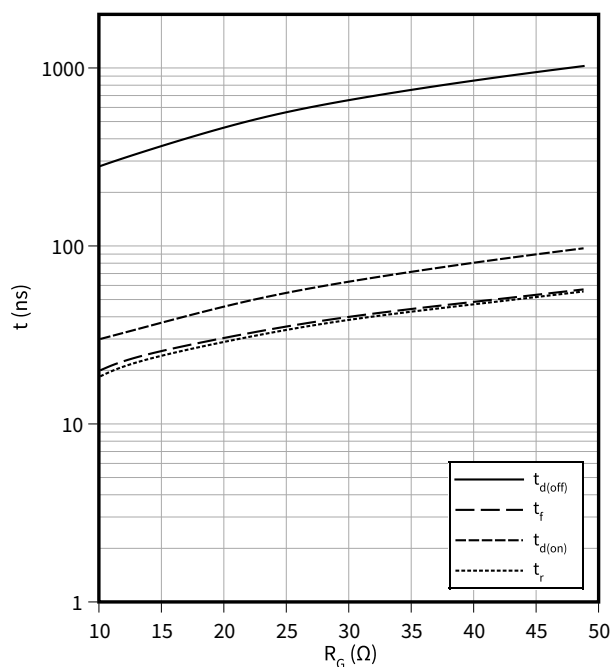
$$t = f(I_C)$$

$$V_{CC} = 400 \text{ V}, T_{vj} = 175^\circ\text{C}, V_{GE} = 0/15 \text{ V}, R_G = 10 \Omega$$

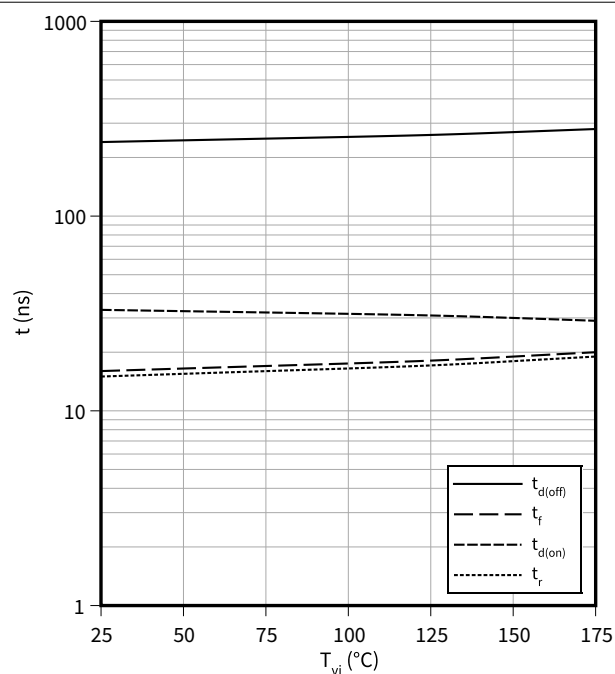


4 Characteristics diagrams
Typical switching times as a function of gate resistor

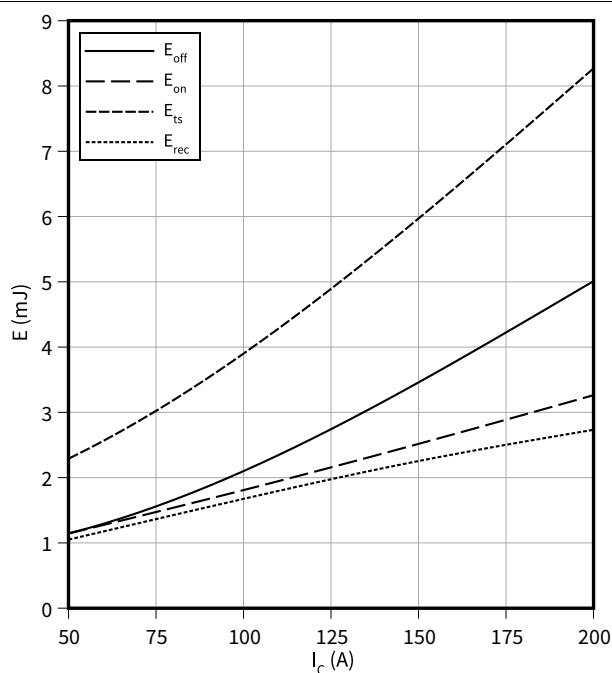
$$t = f(R_G)$$

 $I_C = 100 \text{ A}, V_{CC} = 400 \text{ V}, T_{vj} = 175 \text{ °C}, V_{GE} = 0/15 \text{ V}$

Typical switching times as a function of junction temperature

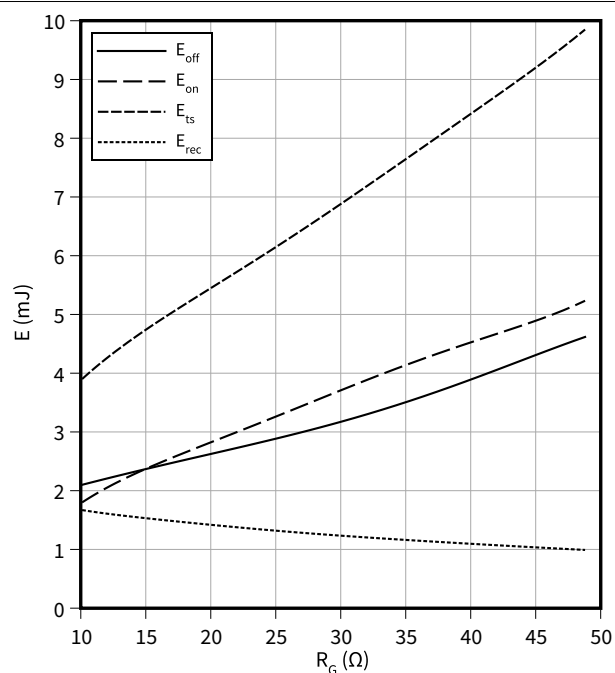
$$t = f(T_{vj})$$

 $I_C = 100 \text{ A}, V_{CC} = 400 \text{ V}, V_{GE} = 0/15 \text{ V}, R_G = 10 \text{ }\Omega$

Typical switching energy losses as a function of collector current

$$E = f(I_C)$$

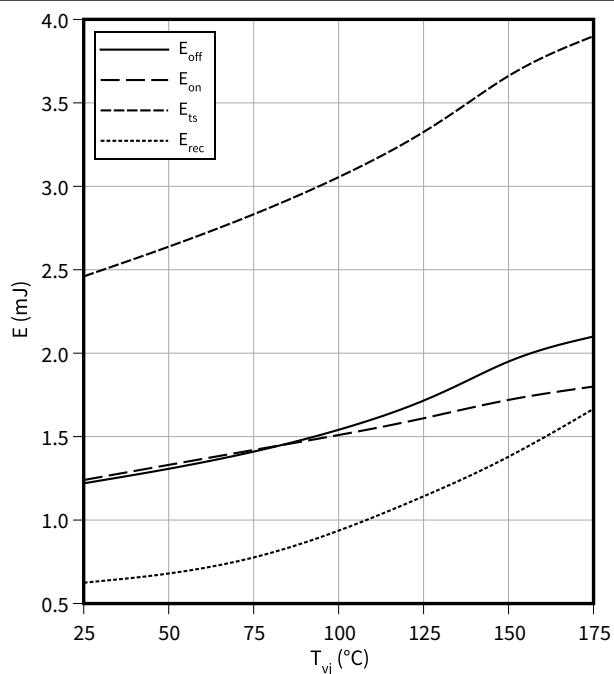
 $V_{CC} = 400 \text{ V}, T_{vj} = 175 \text{ °C}, V_{GE} = 0/15 \text{ V}, R_G = 10 \text{ }\Omega$

Typical switching energy losses as a function of gate resistor

$$E = f(R_G)$$

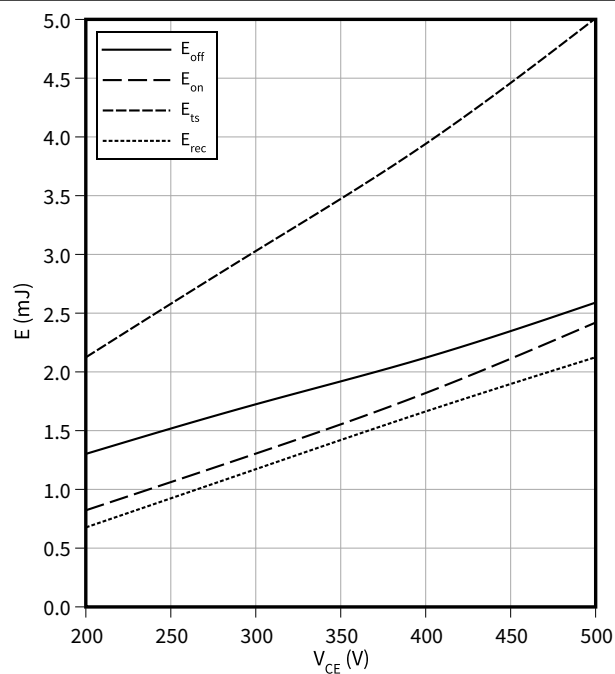
 $I_C = 100 \text{ A}, V_{CC} = 400 \text{ V}, T_{vj} = 175 \text{ °C}, V_{GE} = 0/15 \text{ V}$


4 Characteristics diagrams
Typical switching energy losses as a function of junction temperature

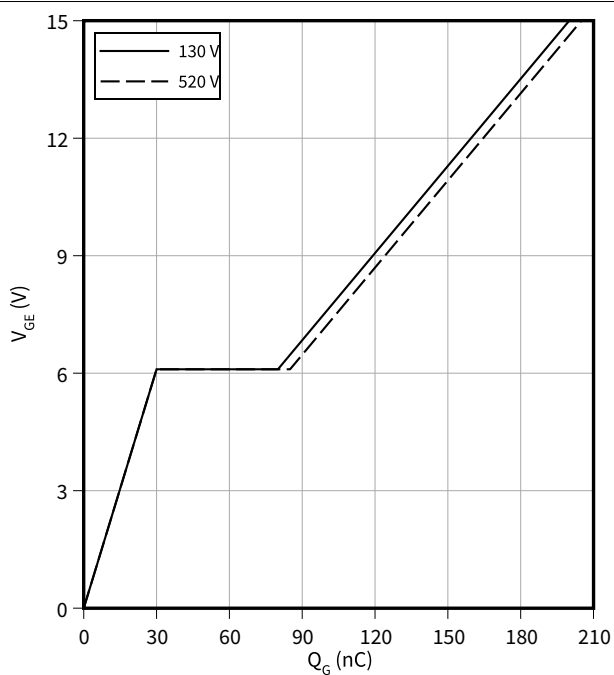
$$E = f(T_{vj})$$

 $I_C = 100 \text{ A}, V_{CC} = 400 \text{ V}, V_{GE} = 0/15 \text{ V}, R_G = 10 \Omega$

Typical switching energy losses as a function of collector emitter voltage

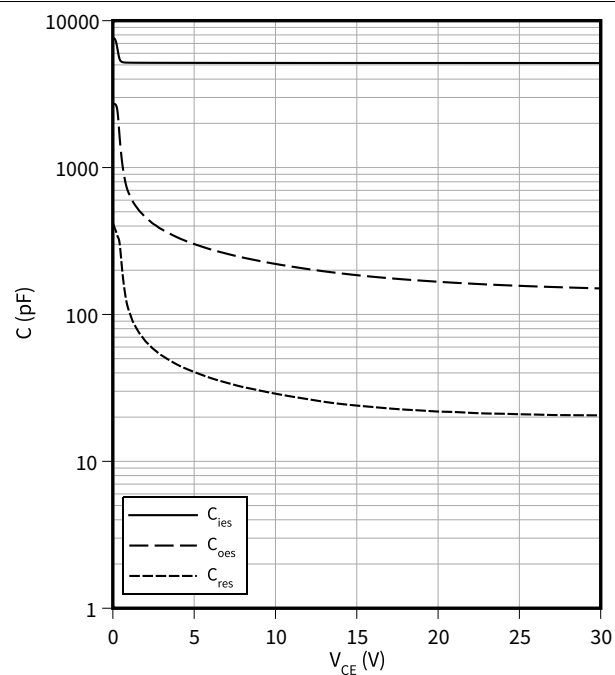
$$E = f(V_{CE})$$

 $I_C = 100 \text{ A}, T_{vj} = 175 \text{ °C}, V_{GE} = 0/15 \text{ V}, R_G = 10 \Omega$

Typical gate charge

$$V_{GE} = f(Q_G)$$

 $I_C = 100 \text{ A}$

Typical capacitance as a function of collector-emitter voltage

$$C = f(V_{CE})$$

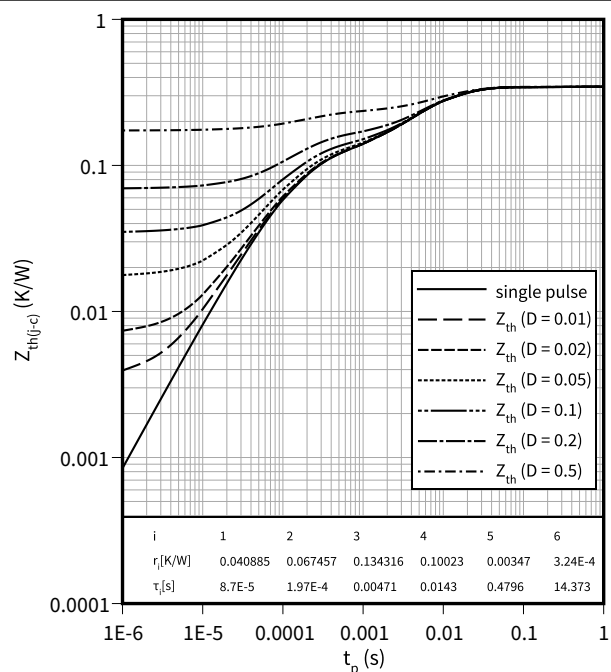
 $f = 100 \text{ kHz}, V_{GE} = 0 \text{ V}$


4 Characteristics diagrams

IGBT transient thermal impedance as a function of pulse width

$$Z_{th(j-c)} = f(t_p)$$

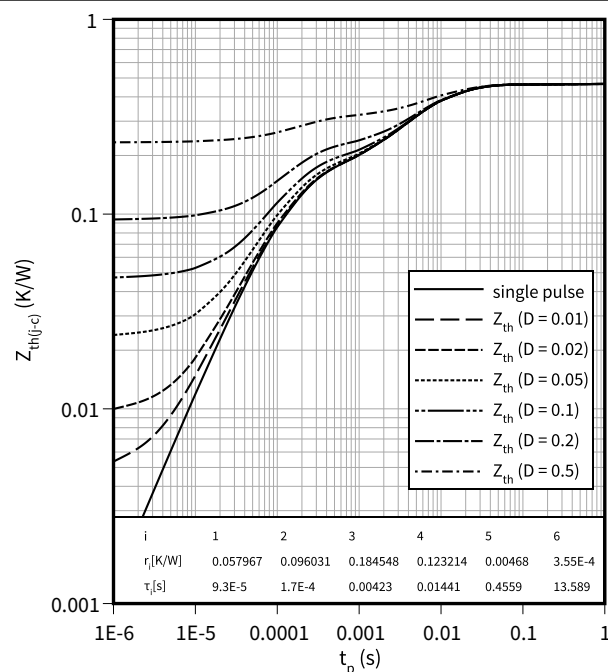
$$D = t_p/T$$



Diode transient thermal impedance as a function of pulse width

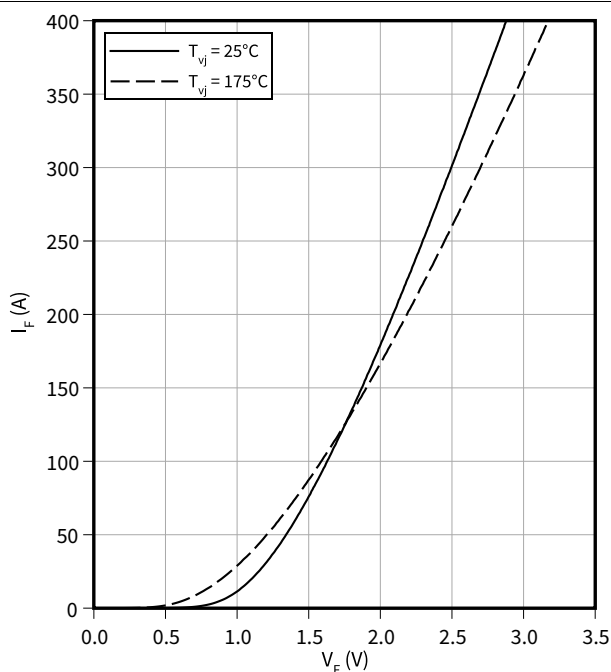
$$Z_{th(j-c)} = f(t_p)$$

$$D = t_p/T$$



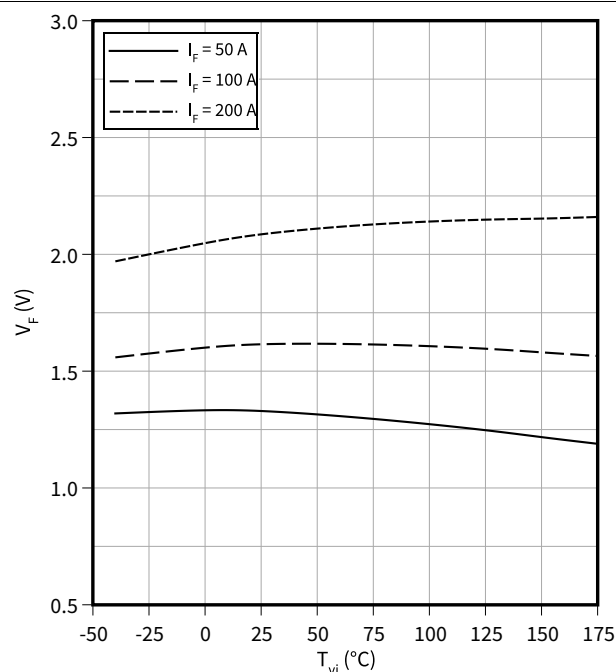
Typical diode forward current as a function of forward voltage

$$I_F = f(V_F)$$



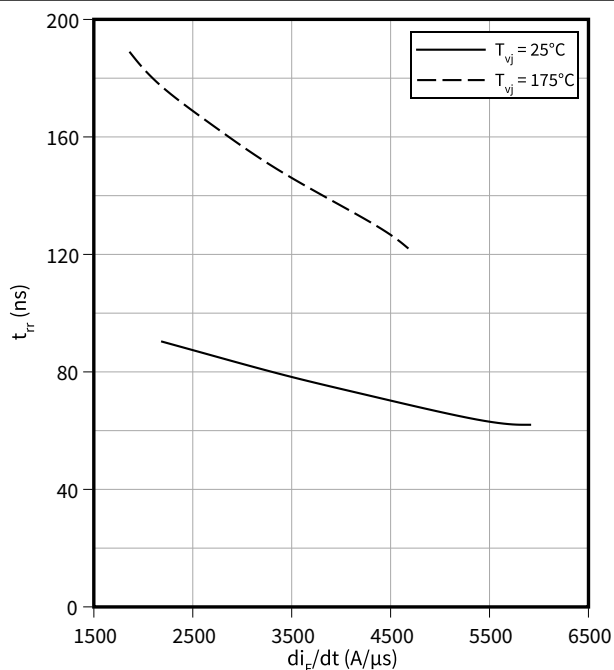
Typical diode forward voltage as a function of junction temperature

$$V_F = f(T_{vj})$$

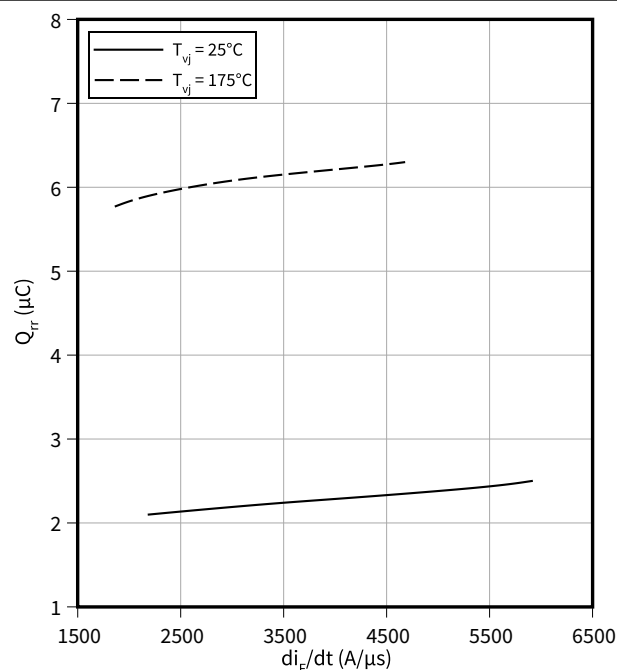


4 Characteristics diagrams
Typical reverse recovery time as a function of diode current slope

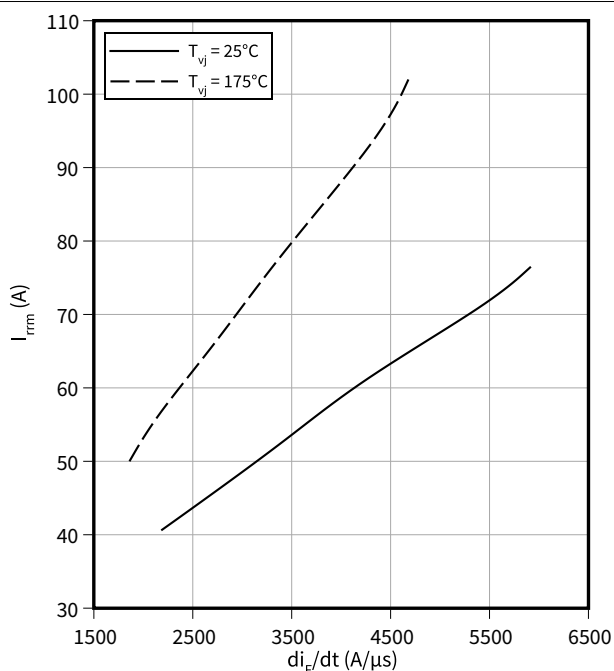
$$t_{rr} = f(di_F/dt)$$

 $V_R = 400 \text{ V}, I_F = 100 \text{ A}$

Typical reverse recovery charge as a function of diode current slope

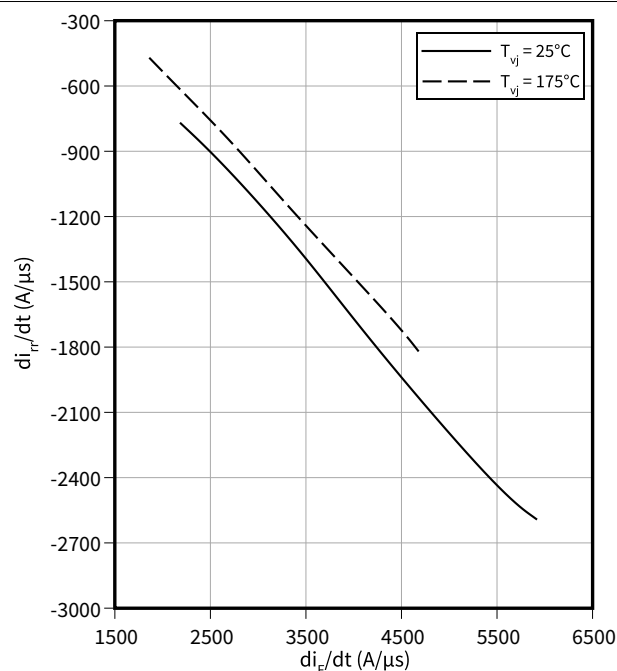
$$Q_{rr} = f(di_F/dt)$$

 $V_R = 400 \text{ V}, I_F = 100 \text{ A}$

Typical reverse recovery current as a function of diode current slope

$$I_{rrm} = f(di_F/dt)$$

 $V_R = 400 \text{ V}, I_F = 100 \text{ A}$

Typical diode peak rate of fall of reverse recovery current as a function of diode current slope

$$di_{rr}/dt = f(di_F/dt)$$

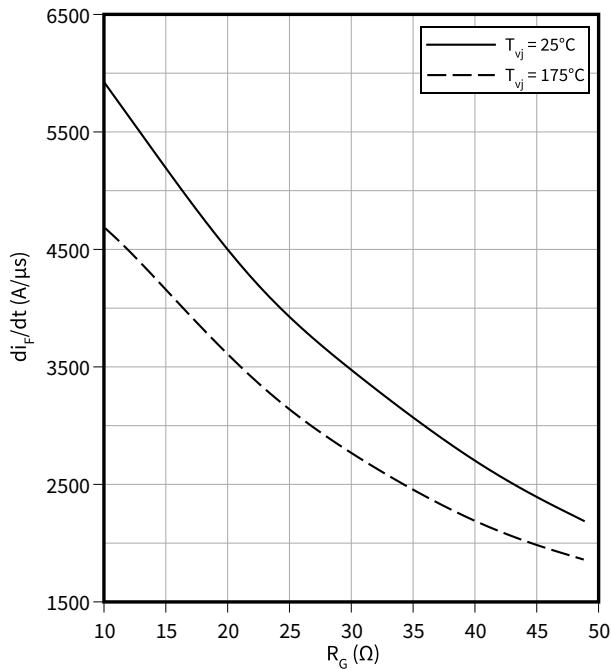
 $V_R = 400 \text{ V}, I_F = 100 \text{ A}$


4 Characteristics diagrams

Typical diode current slope as a function of gate resistor

$di_F/dt = f(R_G)$

$V_R = 400\text{ V}$, $I_F = 100\text{ A}$



5 Package outlines

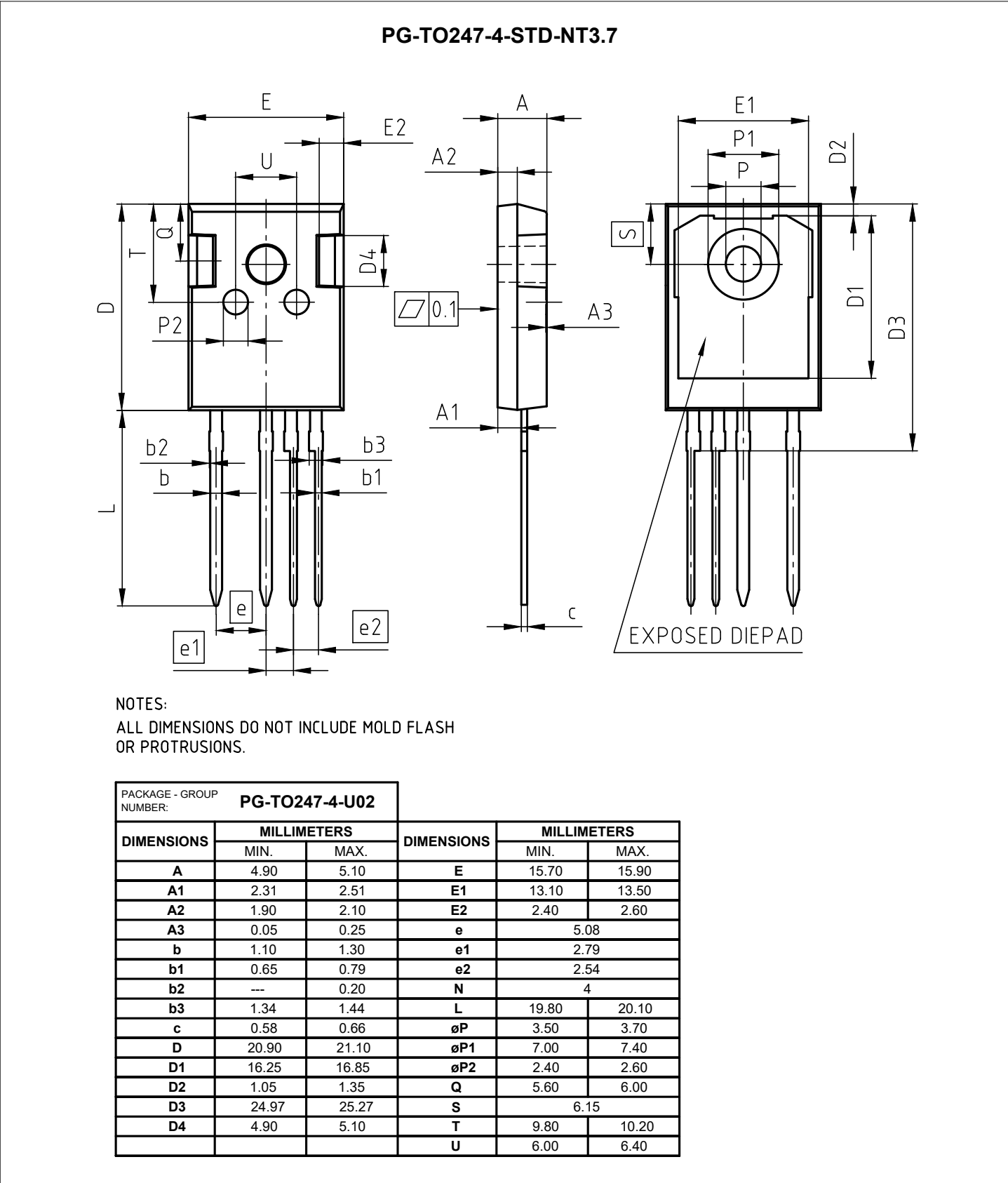


Figure 1

6 Testing conditions

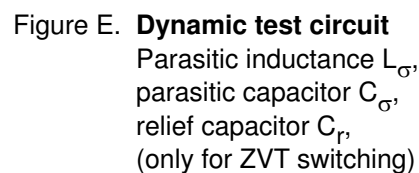


Figure 2

Revision history

Document revision	Date of release	Description of changes
1.00	2023-04-27	Final datasheet
1.10	2023-11-15	Update of energy diagrams

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